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UNITED STATES

DECLARATION FOR PATENT APPLICATION Docket No SOH 14.569 As a below named inventor, I hereby declare that: My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention cutified STRUCTURE AND METHOD FOR MANUFACTURING A SEMICONDUCTOR the specification of which (check one) [X] is attached hereto. was filed on Application Social No. and was amended on I hereby state that I have reviewed and understand the contents of the above identified specification, including the I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a). I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: Prior Foreign Application(s) 8-289568 Japan 31/10/1996 Priority Claimed (Number) (Country) (Day/Month/Year Filed) (Number) (Country) (Day/Month/Year Filed) No (Number) (Country) Yes (Day/Month/Year Filed) No I hereby claim the benefit under Title 35. United State Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, \$112, I acknowledge the duty to discluse material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application: (Application Serial No.) (Filing Date) (Status - patented, pending, abandoned) (Application Social No.) (Filing Date) I hereby appoint as my attorney and agent Aaron B. Karas, Reg. No. 18,923, Samson Helfgott, Reg. (Status - patented, pending, abandoned) No. 23,072, Leonard Cooper Reg. No. 27,625 and Emma Shlelfer, Reg. No. 29,734 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: Address all correspondence to: HELFGOTT & KARAS P.C. 60th Floor Empire State Building New York, New York 10118-0110 Telephone Ho. (212) 643-5000 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may Jeopardize the validity of the application or any patent Full name of sole or first inventor Norihiro IWAI

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On: JUNE 25, 2001

LINDA E. HASTINGS

Any fee due as a result of this paper, not covered by an enclosed check, may be charged on Deposit Acct. No. 08-1634.

Attorney Docket No.: SOH 14.569A

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor

Norihiro IWAI, et al.

Serial No.

Filed

June 25, 2001

Title

STRUCTURE AND METHOD FOR

MANUFACTURING A SEMICONDUCTOR

OPTICAL WAVEGUIDE

Examiner

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Group Art Unit

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Assistant Commissioner for Patents Washington, D.C. 20231

SUB-POWER OF ATTORNEY

SIR:

I, Samson Helfgott, attorney of record herein, do hereby grant a sub-power of attorney to Linda S. Chan, Reg. No. 42,400; Michael I. Markowitz, Reg. No. 30,659; Brian S. Myers, Reg. No. 46,947; and Harris A. Wolin, Reg. No. 39,432 to act and sign in my behalf in the above-referenced application.

Respectfully submitted,

Samson Helfgott/

Reg. No. 23,072(

HELFGOTT & KARAS, P.C. 60TH FLOOR EMPIRE STATE BUILDING NEW YORK, NEW YORK 10118 (212) 643-5000 DOCKET NO.:SOH 14.569A SH:MIM: 1hda:SOH14569A